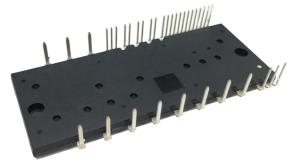


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TRANSFER MOLDING TYPE **INSULATED TYPE**

OUTLINE



MAIN FUNCTION

CI(Converter + Inverter) type IPM

- 3-phase Inverter
- 3-phase Converter

RATING

Inverter part: 35A/1200V (CSTBT)

APPLICATION

AC400V three phase motor inverter drive

INTEGRATED DRIVE, PROTECTION AND SYSTEM CONTROL FUNCTIONS

• For P-side : Drive circuit, High voltage high-speed level shifting,

Control supply under-voltage protection (UV) without fault signal output

Built-in discrete bootstrap diode chips with current limiting resistor

• For N-side : Drive circuit, Control supply under-voltage protection (UV),

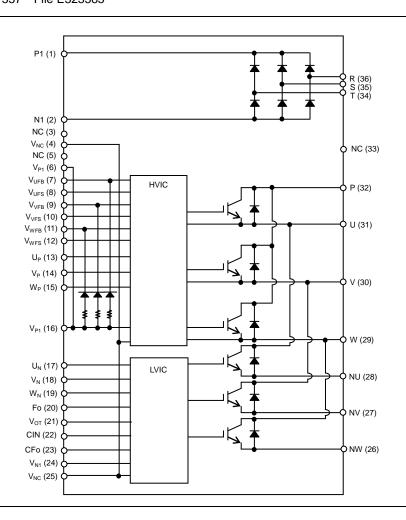
Short circuit protection (SC) by detecting voltage of external shunt resistor

• Fault signaling: Corresponding to SC fault (N-side IGBT) and UV fault (N-side supply)

• Temperature monitoring: Outputting LVIC temperature by analog signal (No self over temperature protection)

• Input interface : 5V high active logic • UL Recognized : UL1557 File E323585

INTERNAL CIRCUIT



TRANSFER MOLDING TYPE

INSULATED TYPE

MAXIMUM RATINGS (T_j = 25°C, unless otherwise noted)

INVERTER PART

| Symbol | Parameter | Condition | Ratings | Unit | |
|------------------------|------------------------------------|--------------------------------------|------------------------------|----------|----|
| V _{CC} | Supply voltage | Applied between P-NU,NV,NW | | 900 | V |
| V _{CC(surge)} | Supply voltage (surge) | Applied between P-NU,NV,NW | | 1000 | V |
| V _{CES} | Collector-emitter voltage | | | 1200 | V |
| ±l _C | Each IGBT collector current | T _C = 25°C | $T_C = 25^{\circ}C$ (Note 1) | | Α |
| ±l _{CP} | Each IGBT collector current (peak) | T _C = 25°C, less than 1ms | | 70 | Α |
| T _j | Junction temperature | | | -30~+150 | °C |

Note1: Pulse width and period are limited due to junction temperature.

CONVERTER PART

| Symbol | Parameter | Condition | Ratings | Unit |
|------------------|---------------------------------|--|----------|------------------|
| V_{RRM} | Repetitive peak reverse voltage | | 1600 | V |
| lo | DC output current | 3-phase full wave rectification | 35 | Α |
| I _{FSM} | Surge forward current | Peak value of half cycle at 60Hz, Non-repetitive | 350 | Α |
| l ² t | I ² t capability | Value for 1 cycle of surge current | 510 | A ² s |
| Ti | Junction temperature | | -30~+150 | °C |

CONTROL (PROTECTION) PART

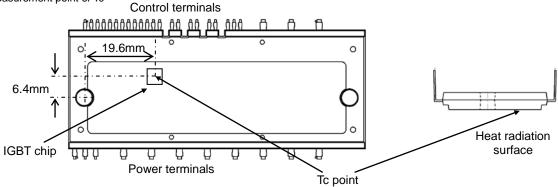
| Symbol | Parameter | Condition Ratings | | | |
|-----------------|-------------------------------|--|--------------------------|----|--|
| V_D | Control supply voltage | Applied between V _{P1} -V _{NC} , V _{N1} -V _{NC} | 20 | V | |
| V_{DB} | Control supply voltage | Applied between V _{UFB} -V _{UFS} , V _{VFB} -V _{VFS} , V _{WFB} -V _{WFS} | 20 | V | |
| V _{IN} | Input voltage | Applied between $U_P, V_P, W_P, U_N, V_N, W_N-V_{NC}$ | -0.5~V _D +0.5 | V | |
| V _{FO} | Fault output supply voltage | Applied between F _O -V _{NC} | -0.5~V _D +0.5 | V | |
| I _{FO} | Fault output current | Sink current at Fo terminal | 5 | mA | |
| V _{SC} | Current sensing input voltage | Applied between CIN-V _{NC} | -0.5~V _D +0.5 | V | |

TOTAL SYSTEM

| Symbol | Parameter | Condition | Ratings | Unit |
|-----------------------|--|--|----------|-----------|
| V _{CC(PROT)} | Self protection supply voltage limit (Short circuit protection capability) | $V_D = 13.5 \sim 16.5 \text{V}$, Inverter Part $T_i = 125 ^{\circ}\text{C}$, non-repetitive, less than $2\mu \text{s}$ | 800 | V |
| T _C | Module case operation temperature | (Note 2) | -30~+110 | °C |
| T _{stg} | Storage temperature | | -40~+125 | °C |
| V _{iso} | Isolation voltage | 60Hz, Sinusoidal, AC 1min, between connected all pins and heat sink plate | 2500 | V_{rms} |

Note2: Measurement point of Tc is described in Fig.1.

Fig. 1 Measurement point of Tc



THERMAL RESISTANCE

| Symbol Parameter | | Condition | | Unit | | |
|------------------|--|-------------------------------------|------|------|------|------|
| | | Condition | Min. | Тур. | Max. | Uill |
| $R_{th(j-c)Q}$ | | Inverter IGBT part (per 1/6 module) | - | - | 0.95 | |
| $R_{th(j-c)F}$ | Junction to case thermal resistance (Note 3) | Inverter FWD part (per 1/6 module) | - | - | 1.30 | K/W |
| $R_{th(j-c)R}$ | (Note 5) | Converter part (per 1/6module) | - | - | 1.10 | |

Note 3: Grease with good thermal conductivity and long-term endurance should be applied evenly with about +100µm~+200µm on the contacting surface of DIPIPM and heat sink. The contacting thermal resistance between DIPIPM case and heat sink Rth(c-f) is determined by the thickness and the thermal conductivity of the applied grease. For reference, Rth(c-f) is about 0.25K/W (per 1chip, grease thickness: 20µm, thermal conductivity: 1.0W/m•K).

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TRANSFER MOLDING TYPE

INSULATED TYPE

ELECTRICAL CHARACTERISTICS (T_j = 25°C, unless otherwise noted) **INVERTER PART**

| Symbol | Parameter | Condition | | Limits | | | Unit | |
|----------------------|------------------------------|--|--------------------------------------|----------|------|------|------|------|
| Syllibol | Farameter | Cond | Condition | | Min. | Тур. | Max. | Onit |
| V _{CE(sat)} | Collector-emitter saturation | V _D =V _{DB} = 15V, V _{IN} = 5V | I _C = 35A, T _j | j= 25°C | - | 1.50 | 2.20 | V |
| V CE(sat) | voltage | VD=VDB = 13V, VIN= 3V | I _C = 35A, T _j | j= 125°C | | 1.80 | 2.45 | V |
| V _{EC} | FWDi forward voltage | V _{IN} = 0V, -I _C = 35A | | - | 2.40 | 3.10 | V | |
| t _{on} | | | | | 1.10 | 1.90 | 2.60 | μs |
| t _{C(on)} | | V_{CC} = 600V, V_{D} = V_{DB} = 15V | $V_{CC} = 600V, V_D = V_{DB} = 15V$ | | - | 0.60 | 0.95 | μs |
| t _{off} | Switching times | I _C = 35A, T _j = 125°C, V _{IN} = 0↔5\ | / | | - | 2.70 | 3.80 | μs |
| $t_{C(off)}$ | | Inductive Load (upper-lower a | rm) | | - | 0.40 | 0.90 | μs |
| t _{rr} | | | | | - | 0.60 | - | μs |
| 1 | Collector-emitter cut-off | V _{CE} =V _{CES} | T _j = | = 25°C | - | ı | 1 | mA |
| I _{CES} | current | V _{CE} =V _{CES} | T _j = | = 125°C | - | - | 10 | IIIA |

CONVERTER PART

| Symbol Parameter | Parameter | Condition - | | Limits | | | |
|------------------|----------------------------|---|---|--------|------|------|--|
| Syllibol | Farameter | | | Тур. | Max. | Unit | |
| I _{RRM} | Repetitive reverse current | V _R =V _{RRM} , Tj=125°C | | - | 7.0 | mA | |
| V _F | Forward voltage drop | I _F =35A | - | 1.1 | 1.4 | V | |

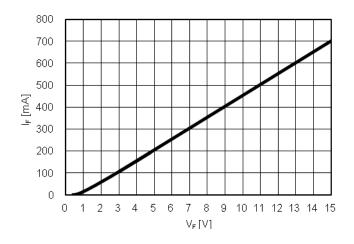
CONTROL (PROTECTION) PART

| Symbol | Parameter | Cond | | Limits | | Unit | |
|----------------------|--|--|--|--------|-------|-------|-------|
| Syllibol | Farameter | Cond | Condition | | | Max. | Offic |
| 1 | | Total of V _{P1} -V _{NC} , V _{N1} -V _{NC} | V _D =15V, V _{IN} =0V | - | - | 4.70 | |
| I _D | Circuit current | TOTAL OF VP1-VNC, VN1-VNC | V _D =15V, V _{IN} =5V | - | - | 4.70 | mA |
| 1 | Circuit current | Each part of V _{UFB} -V _{UFS} , | $V_D=V_{DB}=15V, V_{IN}=0V$ | - | - | 0.55 | IIIA |
| I _{DB} | | V _{VFB} -V _{VFS} , V _{WFB} -V _{WFS} | $V_D=V_{DB}=15V$, $V_{IN}=5V$ | - | - | 0.55 | |
| V _{SC(ref)} | Short circuit trip level | V _D = 15V | (Note 4) | 0.455 | 0.480 | 0.505 | V |
| UV _{DBt} | Control supply under-voltage | | Trip level | 10.0 | - | 12.0 | V |
| UV_DBr | protection(UV) for P-side of inverter part | | Reset level | 10.5 | - | 12.5 | V |
| UV _{Dt} | Control supply under-voltage | | Trip level | 10.3 | - | 12.5 | V |
| UV _{Dr} | protection(UV) for N-side of inverter part | | Reset level | 10.8 | - | 13.0 | V |
| V _{OT} | Temperature Output | Pull down R=5.1kΩ, LVIC Tem | nperature=100°C (Note 5) | 2.89 | 3.02 | 3.14 | V |
| V_{FOH} | Foult output voltage | $V_{SC} = 0V$, F_O terminal pulled up | p to 5V by 10kΩ | 4.9 | - | - | V |
| V _{FOL} | Fault output voltage | V _{SC} = 1V, I _{FO} = 1mA | | - | - | 0.95 | V |
| t _{FO} | Fault output pulse width | In case of C _{Fo} =22nF | (Note 6,7) | 1.6 | 2.4 | - | ms |
| I _{IN} | Input current | $V_{IN} = 5V$ | $V_{IN} = 5V$ | | 1.00 | 1.50 | mA |
| $V_{th(on)}$ | ON threshold voltage | Applied between LL M MM LL M MM M | | - | - | 3.5 | V |
| $V_{th(off)}$ | OFF threshold voltage Applied between U _P ,V _P ,W _P ,U _N , V _N , W | | I, VN, VVN - VNC | 0.8 | - | - |] V |
| V _F | Bootstrap Di forward voltage | I _F =10mA including voltage drop by limiting resistor (Note 8) | | - | 0.9 | 1.3 | V |
| R | Built-in limiting resistance | Included in bootstrap Di | | 16 | 20 | 24 | Ω |

Note 4 : SC protection works only for N-side IGBT in inverter part. Please select the external shunt resistance such that the SC trip-level is less than 1.7 times of the

^{4 :} SC protection works only for N-side IGBT in inverter part. Flease select the external shall resistance source and that the Co the Inverter part is current rating.
5 : DIPIPM don't shutdown IGBTs and output fault signal automatically when temperature rises excessively. When temperature exceeds the protective level that user defined, controller (MCU) should stop the DIPIPM. Temperature of LVIC vs. V_{OT} output characteristics is described in Fig. 3.
6 : Fault signal Fo outputs when SC or UV protection works for N-side IGBT in inverter part. The fault output pulse-width t_{FO} is depended on the capacitance value of C_{FO} (C_{FO} = t_{FO} × 9.1 × 10⁻⁶ [F]).
7 : UV protection also works for P-side IGBT in inverter part without fault signal Fo.
8 : The characteristics of bootstrap Di is described in Fig.2.

Fig. 2 Characteristics of Bootstrap Di V_F-I_F curve (@Ta=25°C) Including Voltage Drop by Limiting Resistor (Right chart is enlarged chart.)



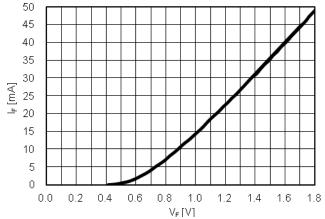
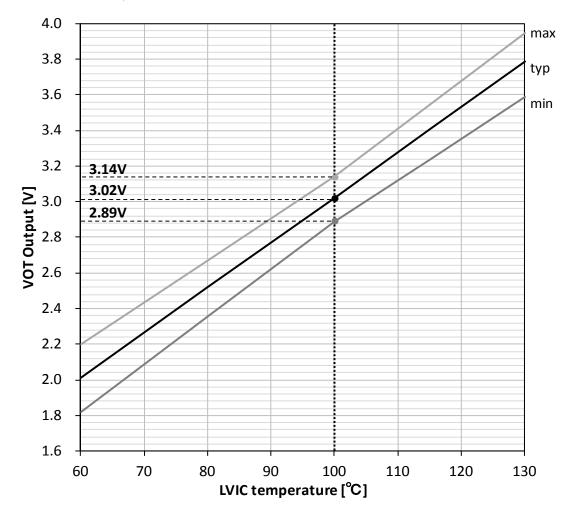


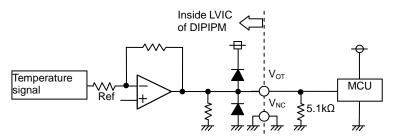
Fig. 3 Temperature of LVIC vs. VoT Output Characteristics



TRANSFER MOLDING TYPE

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Fig. 4 Pattern Wiring Around the Analog Voltage Output Circuit [VoT terminal]



- (1) V_{OT} outputs the analog signal that is amplified signal of temperature detecting element on LVIC by inverting amplifier. (2) It is recommended to insert $5k\Omega$ (5.1 $k\Omega$ is recommended) pull down resistor for getting linear output characteristics at low temperature below room temperature. When the pull down resistor is inserted between V_{OT} and V_{NC}(control GND), the extra circuit current, which is calculated approximately by VoT output voltage divided by pull down resistance, flows as LVIC circuit current continuously. In the case of using VoT for detecting high temperature over room temperature only, it is unnecessary to insert the pull down resistor.
- (3) In the case of not using V_{OT} , leave V_{OT} output NC (No Connection).

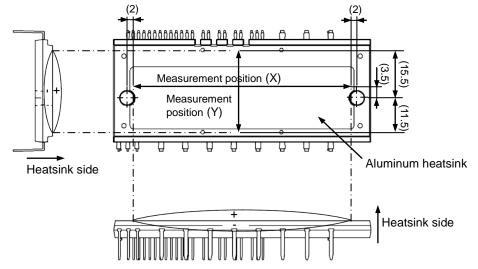
Refer the application note for DIPIPM+ series about the usage of Vor.

MECHANICAL CHARACTERISTICS AND RATINGS

| Parameter | Condition | | | Unit | | |
|------------------------------|------------------------------|---------------------|------|------|------|-------|
| Farameter | | | Min. | Тур. | Max. | Offic |
| Mounting torque | Mounting screw : M4 (Note 9) | Recommended 1.18N·m | 0.98 | 1.18 | 1.47 | N⋅m |
| Terminal pulling strength | 20N load | EIAJ-ED-4701 | 10 | - | - | S |
| Terminal bending strength | 90deg bending with 10N load | EIAJ-ED-4701 | 2 | - | - | times |
| Weight | | | - | 40 | - | g |
| Heat radiation part flatness | | (Note 10) | -50 | - | +100 | μm |

Note 9: Plain washers (ISO 7089~7094) are recommended.

Note 10: Measurement positions of heat radiation part flatness are as below.



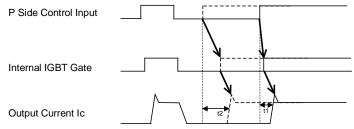
TRANSFER MOLDING TYPE

INSULATED TYPE

RECOMMENDED OPERATION CONDITIONS

| Symbol | Parameter | Condition | | Limits | | | Unit |
|--------------------------------|---------------------------------|---|--|--------|------|------|-------|
| Symbol Farameter | | Condition | Condition | | Тур. | Max. | Offic |
| V _{CC} | Supply voltage | Applied between P-NU,NV,NW | | 0 | 600 | 800 | V |
| V_D | Control supply voltage | Applied between V _{P1} -V _{NC} ,V _{N1} -V _{NC} | | 13.5 | 15.0 | 16.5 | V |
| V_{DB} | Control supply voltage | Applied between V _{UFB} -V _{UFS} ,V _{VFB} -V | _{VFS} ,V _{WFB} -V _{WFS} | 13.0 | 15.0 | 18.5 | V |
| ΔV_D , ΔV_{DB} | Control supply variation | | | -1 | - | 1 | V/µs |
| t _{dead} | Arm shoot-through blocking time | For each input signal | For each input signal | | | - | μs |
| f _{PWM} | PWM input frequency | T _C ≤100°C, T _j ≤125°C | - | - | 20 | kHz | |
| PWIN(on) | | I _C ≤1.7 times of rated current | (Note 11) | 1.5 | - | - | |
| | | 0≤V _{CC} ≤800V, 13.5≤V _D ≤16.5V, | Less than rated current | 3.0 | - | - | |
| PWIN(off) | Minimum input pulse width | $\begin{array}{ll} 13.0{\leq}V_{DB}{\leq}18.5V, -20{\leq}T_{C}{\leq}100^{\circ}C,\\ N \text{ line wiring inductance}\\ \text{less than }10\text{nH} & (\text{Note }12) \end{array}$ | From rated current to 1.7 times of rated current | 3.5 | - | - | μs |
| V _{NC} | V _{NC} variation | Between V _{NC} - NU、NV、NW (including surge) | | | - | +5.0 | V |
| Tj | Junction temperature | | | -20 | - | 125 | °C |

About Delayed Response Against Shorter Input Off Signal Than PWIN(off) (P side only)



Real line...off pulse width>PWIN(off); turn on time t1 Broken line···off pulse width<PWIN(off); turn on time t2

Note 11: DIPIPM might not make response if the input signal pulse width is less than PWIN(on).

12: DIPIPM might make no response or delayed response (P-side IGBT only) for the input signal with off pulse width less than PWIN(off). Please refer below figure about delayed response.

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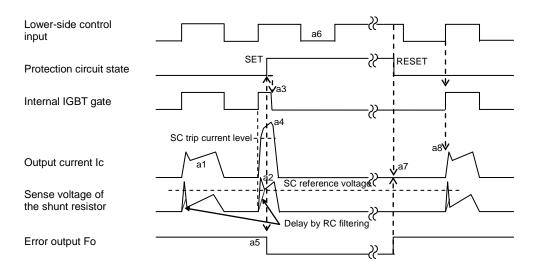
Fig. 5 Timing Charts of The DIPIPM Protective Functions

[A] Short-Circuit Protection (N-side only with the external shunt resistor and RC filter)

- a1. Normal operation: IGBT ON and outputs current.
- a2. Short circuit current detection (SC trigger)

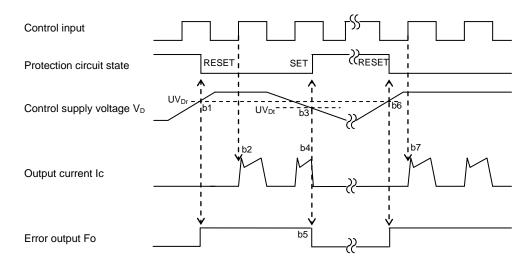
(It is recommended to set RC time constant 1.5~2.0µs so that IGBT shut down within 2.0µs when SC.)

- a3. All N-side IGBT's gates are hard interrupted.
- a4. All N-side IGBTs turn OFF.
- a5. LVIC starts outputting fault signal (fault signal output time is controlled by external capacitor C_{FO})
- a6. Input = "L": IGBT OFF
- a7. Fo finishes output, but IGBTs don't turn on until inputting next ON signal (L→H). (IGBT of each phase can return to normal state by inputting ON signal to each phase.)
- a8. Normal operation: IGBT ON and outputs current.



[B] Under-Voltage Protection (N-side, UV_D)

- b1. Control supply voltage V_D exceeds under voltage reset level (UV_{Dr}), but IGBT turns ON by next ON signal (L \rightarrow H). (IGBT of each phase can return to normal state by inputting ON signal to each phase.)
- b2. Normal operation: IGBT ON and outputs current.
- b3. V_D level drops to under voltage trip level. (UV_{Dt}).
- b4. All N-side IGBTs turn OFF in spite of control input condition.
- b5. Fo outputs for the period set by external capacitor CFO, but output is extended during VD keeps below UVDr.
- b6. V_D level reaches UV_{Dr} .
- b7. Normal operation: IGBT ON and outputs current.



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- [C] Under-Voltage Protection (P-side, UV_{DB})
- c1. Control supply voltage V_{DB} rises. After the voltage reaches under voltage reset level UV_{DBr} , IGBT turns on by next ON signal (L \rightarrow H).
- c2. Normal operation: IGBT ON and outputs current.
- c3. V_{DB} level drops to under voltage trip level (UV_{DBt}).
- c4. IGBT of the correspond phase only turns OFF in spite of control input signal level, but there is no Fo signal output.
- c5. V_{DB} level reaches UV_{DBr} .
- c6. Normal operation: IGBT ON and outputs current.

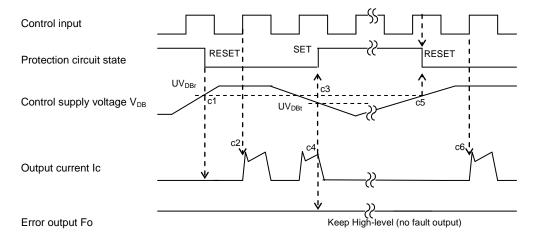
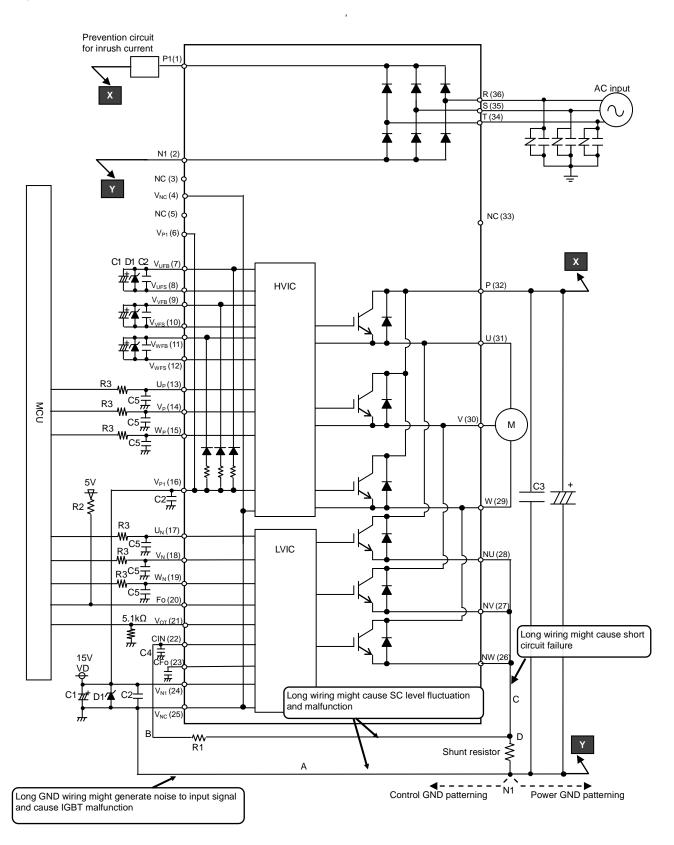


Fig. 6 Example of Application Circuit



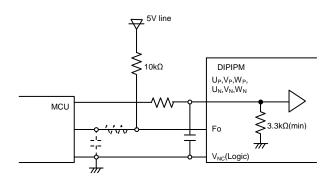
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TRANSFER MOLDING TYPE INSULATED TYPE

Note for the previous application circuit

- (1) If control GND is connected with power GND by common broad pattern, it may cause malfunction by power GND fluctuation. It is recommended to connect control GND and power GND at only a point N1 (near the terminal of shunt resistor).
- (2) It is recommended to insert a Zener diode D1(24V/1W) between each pair of control supply terminals to prevent surge destruction.
- (3) To prevent surge destruction, the wiring between the smoothing capacitor and the P, N1 terminals should be as short as possible. Generally a 0.1-0.22µF snubber capacitor C3 between the P-N1 terminals is recommended.
- (4) R1, C4 of RC filter for preventing protection circuit malfunction is recommended to select tight tolerance, temp-compensated type. The time constant R1C4 should be set so that SC current is shut down within 2μs. (1.5μs~2μs is recommended generally.) SC interrupting time might vary with the wiring pattern, so the enough evaluation on the real system is necessary.
- (5) To prevent malfunction, the wiring of A, B, C should be as short as possible.
- (6) The point D at which the wiring to CIN filter is divided should be near the terminal of shunt resistor. NU, NV, NW terminals should be connected each other at near those three terminals when it is used by one shunt operation. Low inductance SMD type with tight tolerance, temp-compensated type is recommended for shunt resistor.
- (7) All capacitors should be mounted as close to the terminals as possible. (C1: good temperature, frequency characteristic electrolytic type and C2:0.01μ-2μF, good temperature, frequency and DC bias characteristic ceramic type are recommended.)
- (8) Input logic is High-active. There is a 3.3kΩ(min.) pull-down resistor in the input circuit of IC. To prevent malfunction, the input wiring should be as short as possible. When using RC coupling, make the input signal level meet the turn-on and turn-off threshold voltage.
- (9) Fo output is open drain type. Fo output will be max 0.95V(@I_{FO}=1mA,25°C), so it should be pulled up to MCU or control power supply (e.g. 5V,15V) by a resistor that makes I_{FO}up to 1mA. (In the case of pulled up to 5V, 10kΩ is recommended.) About driving opto coupler by Fo output, please refer the application note of this series.
- (10) Fo pulse width can be set by the capacitor connected to CFO terminal. $C_{FO}(F) = 9.1 \times 10^{-6} \text{ x t}_{FO}$ (Required Fo pulse width).
- (11) If high frequency noise superimposed to the control supply line, IC malfunction might happen and cause DIPIPM erroneous operation. To avoid such problem, line ripple voltage should meet dV/dt ≤+/-1V/μs, Vripple≤2Vp-p.
- (12) For DIPIPM, it isn't recommended to drive same load by parallel connection with other phase IGBT or other DIPIPM.
- (13) No.4 and No.25 V_{NC} terminals (GND terminal for control supply) are connected mutually inside of DIPIPM+ and also No.6 and No.16 V_{P1} terminals are connected mutually inside, please connect either No.4 or No.25 terminal to GND and also connect either No.6 or No.16 terminal to supply and make the unused terminal leave no connection.

Fig. 7 MCU I/O Interface Circuit



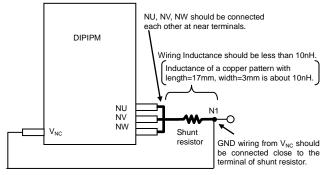
Note)

Design for input RC filter depends on the PWM control scheme used in the application and the wiring impedance of the printed circuit board. But because noisier in the application for 1200V rating, it is strongly recommended to insert RC filter. (Time constant: over 100ns. e.g. 100Ω , 1000pF)

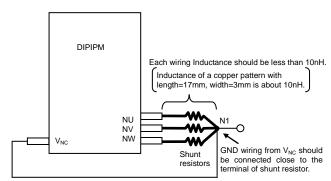
The DIPIPM input signal interface integrates a min. $3.3k\Omega$ pull-down resistor. Therefore, when using RC filter, be careful to satisfy turn-on threshold voltage requirement.

Fo output is open drain type. It should be pulled up to the positive side of 5V or 15V power supply with the resistor that limits Fo sink current I_{Fo} under 1mA. In the case of pulling up to 5V supply, over $5.1k\Omega$ is needed. (10k Ω is recommended.)

Fig. 8 Pattern Wiring Around the Shunt Resistor

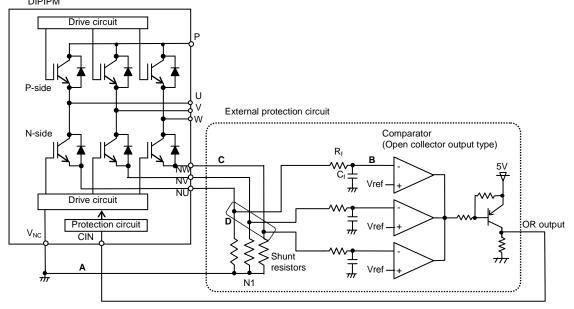


Low inductance shunt resistor like surface mounted (SMD) type is recommended.



TRANSFER MOLDING TYPE

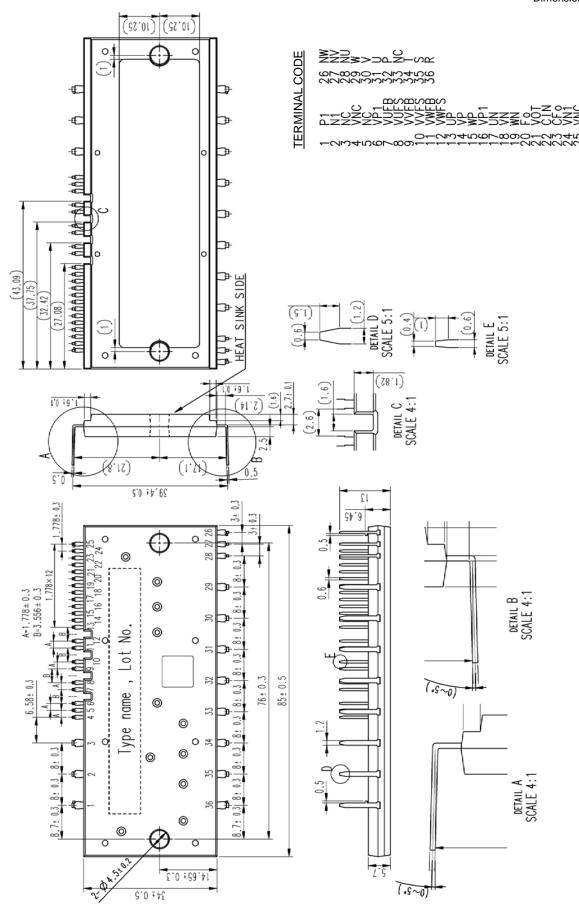
Fig. 9 External SC Protection Circuit with Using Three Shunt Resistors



- (1) It is necessary to set the time constant R_fC_f of external comparator input so that IGBT stop within $2\mu s$ when short circuit occurs. SC interrupting time might vary with the wiring pattern, comparator speed and so on.
- (2) The threshold voltage Vref should be set up the same rating of short circuit trip level (Vsc(ref) typ. 0.48V).
- (3) Select the external shunt resistance so that SC trip-level is less than specified value.
- (4) To avoid malfunction, the wiring A, B, C should be as short as possible.
- (5) The point D at which the wiring to comparator is divided should be near the terminal of shunt resistor.
- (6) OR output high level should be over 0.505V (=maximum Vsc(ref)).
- (7) GND of Comparator, Vref circuit and Cf should be not connected to noisy power GND but to control GND wiring.

Fig. 10 Package Outlines

Dimensions in mm



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TRANSFER MOLDING TYPE

INSULATED TYPE

Revision Record

| Rev. | Date | Page | Revised contents |
|------|------------|------|------------------------------|
| 1 | 29/04/2016 | - | New |
| 2 | 20/05/2016 | 5 | Revise side views of Note 10 |

Publication Date: May 2016

TRANSFER MOLDING TYPE INSULATED TYPE

Keep safety first in your circuit designs!

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